■ SPECIFICATION

Item			LY (C,R) A () (Y,E,V)	LY (A,P) A () (Y,E,V)	
Contact Data	Configuration		1 form C (SPDT)	1 form A (SPST-NO)	
	Construction		Single		
	Material		Y: AgSnO ₂ / E: AgNi / V: AgSnO ₂ + Au plating		
	Resistance (initial)		Y, E: Max. 100 m Ω at 6 VDC, 1 A V: Max. 30 m Ω at 6 VDC, 1A		
	Contact rating		6A, 250VAC / 24VDC (resistive)		
	Max. carrying current		6A		
	Max. switching voltage		250VAC		
	Max. switching power		1,500VA / 144W		
	Min. switching load *		Y, E: 100 mA 5 VDC V: 10mA 5 VDC		
Life	Mechanical		Min. 10 x 10 ⁶ operations		
	Electrical		Min. 50×10^3 operations (N.O.) Min. 30×10^3 operations (N.C.) at 6A, 250VAC / 24VDC resistive		
Coil Data	Rated power		170 to 217 mW		
	Operate power		74 to 95 mW		
	Operating temperature range		-40 °C to +85 °C (no frost)		
Timing Data	Operate (at nominal voltage)		Max. 8ms (no diode, without bounce)		
	Release (at nominal voltage)		Max. 4ms (no diode, without bounce)		
Insulation	Resistance (initial)		Min. 1,000MΩ at 500VDC		
	Dielectric strength	Open contacts	1,000VAC (50/60Hz) 1min.,	10mA detection current	
		Contacts to coil	4,000VAC (50/60Hz) 1min.,	10mA detection current	
	Surge strength	Coil to contacts	6,000V / 1.2 x 50µs standard wave		
	Clearance		Min. 8 mm		
	Creepage		Min. 8 mm		
	EN61810-1, VDE0435	Voltage	250V		
		Pollution degree	3		
		Material group	III a		
		Category	C / 250V		
Other	Vibration resistance E	Misoperation	10 to 55 to 10Hz single amplitude 0.5mm		
		Endurance	10 to 55 to 10hz single amp		
	Shock	Misoperation	Min. $50 \text{m/s}^2 (11 \pm 1 \text{ms})$	Min. 100m/s ² (11 ± 1ms)	
		Endurance	Min. $1,000 \text{m/s}^2 \text{ (6 ± 1ms)}$		
	Weight		Approximately 5 g		
	Sealing		Plastic sealed RTIII		

^{*} Minimum switching loads mentioned above are reference values. Please perform the confirmation test with actual load before production since reference values may vary according to switching frequencies, environmental conditions and expected reliability levels.

COIL RATING

Coil Code	Rated Coil Voltage (VDC)	Coil Resistance +/- 10% (Ohm)	Must Operate Voltage (VDC) *	Must Release- Voltage (VDC) *	Rated Power (mW)
005	5	147	3.3	0.25	
006	6	211	4	0.3	
009	9	476	5.9	0.45	170
012	12	847	7.9	0.6	-
018	18	1,910	11.9	0.9	
024	24	3,390	15.9	1.2	
048	48	10,600	31.7	2.4	217
060	60	20,570	39.6	3	175

*: Specified operate values are valid for pulse wave voltage

Note 1: All values given in the coil table(s) are valid at 20°C ambient temperature, at zero contactcurrent, without pre-energizing and are specified at pulse wave voltage.

Note 2: When applying a higher than rated coil voltage, please refer to the "coil temperature rise" and "operating range" reference graphs, for the effects on the relay operating behaviour.

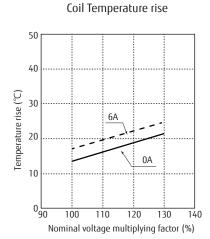
SAFETY STANDARDS

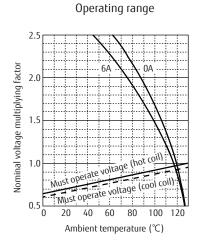
Туре	Compliance	Contact rating	
UL	UL 508	Flammability: UL 94-V0 (plastics)	
	E63614	6A, 277 VAC (resistive) 6A, 30 VDC (resistive)	
CSA	C22.2 No. 14 LR 40304	1/10 hp, 277VAC/125VAC 1/8hp, 277VAC/125VAC Pilot duty: D300, C300, R300, B300	
VDE	IEC/EN61810-1	6A 250VAC (cosφ=1), 6A 30VDC (0ms) 3 (1.5)A, 250VAC	
	EN 60730-1 Clause 12.2, 13.2, 20.1, 20.2, 20.3, 17.5, 17.7, 17.8		
	EN 60335-1 Clause 15.3, 16.3, 29.1, 29.2, 29.3		

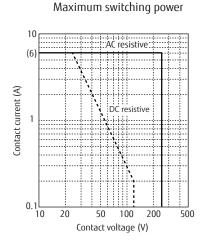
Also conform to UL61010-1, UL61010-2-201, IEC/EN61010-1, IEC/EN61010-2-201 (277VAC)

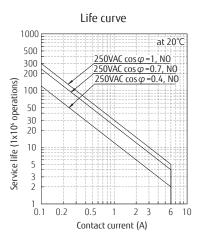
CHARACTERISTIC DATA (For reference only)

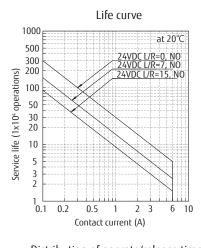
(Characteristic data is not guaranteed value but measured values of samples from production line.)

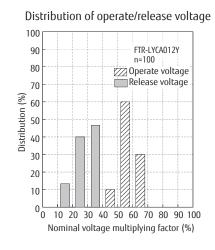


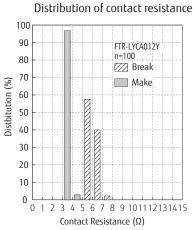


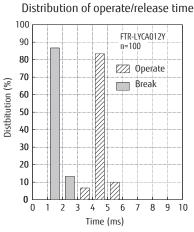






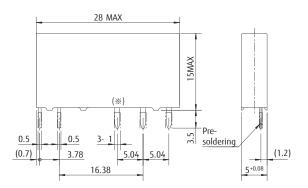






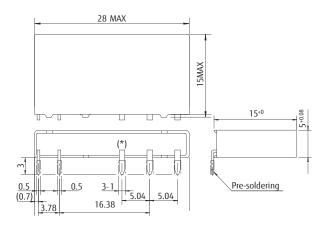
DIMENSIONS

Straight type



Right angle type

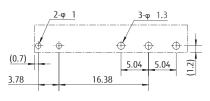
Right angle type



Schematics (BOTTOM VIEW)

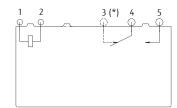


PCB Layout (BOTTOM VIEW)

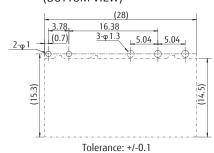


Tolerance: +/-0.1

Schematics (BOTTOM VIEW)

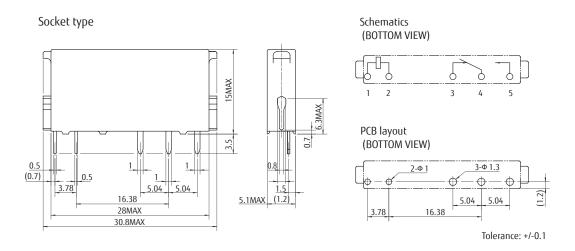


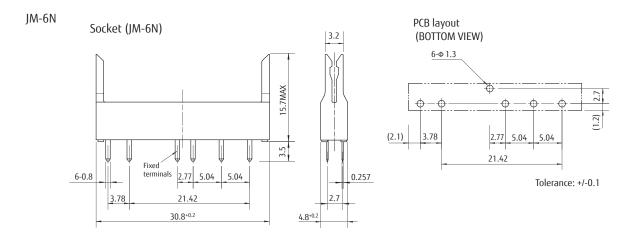
PCB Layout (BOTTOM VIEW)



* The terminal marked (*) is not applicable for 1 form A type.
* Dimensions of the terminals do not include thickness of pre-solder.

(): Reference value Unit: mm





^{*} Dimensions of the terminals of JM-6N do not include thickness of pre-solder.

(): Reference value Unit: mm

Note: Tolerance of PC board mounting hole layout: ±0.1 unless otherwise specified.

Note: Dimensions of the terminals do not include thickness of pre-solder.

Note: This datasheet provide only + tolerance for outer dimensions. Please ask for specification in case you need other tolerances.

Cautions

- All values mentioned in this datasheet are provided under ideal conditions. Please perform the confirmation test before actual use.
- Reflow soldering is prohibited.
- Do not use relays in the atmosphere with sulfide gas, chloride gas or nitric oxide. Contact resistance may
 increase
- Do not use silicon or silicon-containing product or materials near relays. It may cause contact failure.

RoHS Compliance and Lead Free Information

1. General Information

- All relays produced by Fujitsu Components are compliant with RoHS directive 2011/65/EU including amendments.
- Cadmium as used in electrical contacts is exempted from the RoHS directives. As per Annex III of directive 2011/65/EU.
- All relays are lead-free. Please refer to Lead-Free Status Info for older date codes at: http://www.fujitsu.com/downloads/MICRO/fcai/relays/lead-free-letter.pdf
- Lead free solder plating on relay terminals is Sn-3.0Ag-0.5Cu, unless otherwise specified. This material has been verified to be compatible with PbSn assembly process.

2. Recommended Lead Free Solder Condition

• Recommended solder Sn-3.0Ag-0.5Cu.

Flow Solder Condition:

Pre-heating: maximum 120°C within 90 sec

Soldering: dip within 5 sec. at 255 °C ±

5°C solder bath

Relay must be cooled by air immediately after

soldering

Solder by Soldering Iron:

Soldering Iron: 30-60W

Temperature: maximum 350-360°C

Duration: maximum 3 sec.

We highly recommend that you confirm your actual solder conditions

3. Moisture Sensitivity

• Moisture Sensitivity Level standard is not applicable to electromechanical relays, unless otherwise indicated.

4. Tin Whiskers

• Dipped SnAgCu solder is known as presenting a low risk to tin whisker development. No considerable length whisker was found by our in house test.

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